

Title (en)

Holed gypsum plate and method for manufacturing a suspended ceiling

Title (de)

Gips-Lochplatte und Verfahren zur Herstellung einer abgehängten Decke

Title (fr)

Plaque à trou en plâtre et procédé de fabrication d'une couverture suspendue

Publication

EP 2034100 A3 20110831 (DE)

Application

EP 08015081 A 20080827

Priority

DE 102007042251 A 20070906

Abstract (en)

[origin: EP2034100A2] The board (1) has a lower surface provided with a fleece layer and a layer of acoustic plaster, where a set of strip-like hole-free regions (3) is provided within the board. A set of hole surface portions is greater than 30 percentage of the board. The regions run parallel to each other at regular distances. The regions run adjacent to each longitudinal edge of the board. A foil and/or a fleece are applied on a side turned away from a visible side. Longitudinal front sides and transverse front sides with right-angled edges are changed into upper and lower surfaces. An independent claim is also included for a method for manufacturing a suspended ceiling under utilization of a perforated gypsum board.

IPC 8 full level

E04B 9/04 (2006.01); **E04B 1/84** (2006.01)

CPC (source: EP)

E04B 9/045 (2013.01); **E04B 2001/848** (2013.01)

Citation (search report)

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Designated contracting state (EPC)

AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MT NL NO PL PT RO SE SI SK TR

Designated extension state (EPC)

AL BA MK RS

DOCDB simple family (publication)

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DOCDB simple family (application)

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